## **GaN Marathon 2024**

Preliminary Conference Program

June 10-12, 2024 | Verona, Italy

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Hotel Due Torri, Verona								
REGISTRATION and WELCOME, from 16:00 to 18:00								
Monday June 10, 2024								
Hotel Due Torri, Verona								
8:00	REGISTRATION and WELCOME							
9:00		OPENING CERE	MONY – Matteo Meneghini (General Chair)					
0.70	1/	Live dei Aussin	10A - KEYNOTE SESSION					
9:30	Keynote	Hiroshi Amano	Nagoya University, Vertical devices on bulk nitride substrates  Infineon Technologies, Integrated GaN Partitioning: Challenges and					
10:00	Keynote	Anthony Sanders	Solutions					
10:30	Keynote	Aurelien David	Google, Revisiting the physics of InGaN LEDs: Myths and facts					
11:00	Coffee break  10B - OPTOELECTRONIC DEVICES 1							
11.20	Invited		ams OSRAM, Game Changing semiconductor Technologies - From high-					
11:20	Invited	Ulrich Steegmueller	power to miniaturized and smart LEDs  Institute of Physics, School of Basic Sciences, EPFL, Efficiency of III-nitride					
11:40	Invited	Nicolas Grandjean	quantum wells: the importance of point defects					
12:00	Invited	Rachel Oliver	<b>Department of Materials Science and Metallurgy, Cambridge University</b> , Microscopy of cubic nitrides for LEDs					
12:20	Invited	Tim Wernicke	Technische Universität Berlin, Institute of Solid State Physics,					
			Metalorganic vapor phase epitaxy of AlGaN based UVC LEDs  TU Chemnitz, Institute of Physics, Transition between quantum					
12:40	Invited	Ulrich Schwarz	confinement and bulk-like behavior in wide polar quantum wells					
13:00	(5	Nii- D. Din Di	Lunch Break					
	(F	<u> Pizzeria Da Pino, Piazza</u>	Bra, 15 min Walking Distance from the Conference)  10C - RF DEVICES 1					
17.70	Invited	Michael Mikulla	Fraunhofer IAF – Inatech, Advances in mm-Wave Gallium Nitride HEMTS and					
14:30			MMICs in Gain and Efficiency					
14:50	Invited	Jose Jimenez Eduardo Marty	Qorvo, 20 lessons learnt on 20 years working in GaN-RF  Raytheon Technologies, Millimeter-wave ScAIN RF Transistors – Status and Future					
15:10	Invited	Chumbes	Direction					
15:30	Student	Franco Ercolano	University of Bologna, TCAD analysis of the High-Temperature Reverse-Bias Stress on AlGaN/GaN HEMT					
15:40	Invited	Farid Medjdoub	CNRS-IEMN, The next millimeter-wave breakthrough coming up with advanced AIN/GaN transistors					
16:00	Student	Aniruddhan Gowrisankar	IISC, Engineering a Low RF Loss HEMT-on-Silicon					
16:10	Invited	Patrick Fay	Department of Electrical Engineering, University of Notre Dame, Advances in Polarization Engineering for Power, Linearity, and Thermal Management					
16:30			Coffee break					
			10D - POWER DEVICES 1					
16:50	Invited	Kalparupa Mukherjee	<b>CamGaN Devices</b> , Next generation of ICeGaN for superior no load and light load performance					
17:10	Invited	Tetsuo Narita	<b>Toyota Central R&amp;D Labs.,Inc.</b> , Engineering of Channel Mobility, Threshold Voltage and Reliability in GaN MOSFETs Using AlSiO/AlN Gate Stacks Formed By Plasma-Enhanced Atomic Layer Deposition					
17:30	Student	Shun Lu	Nagoya University, Recess-etching-free GaN p-MOSFET achieved by p-type contact to GaN/AlGaN heterojunction with Mg-annealing process					
17:40	Invited	Srabanti Chowdhury	<b>Stanford University</b> , Diamond on GaN: On achieving low temperature growth and low thermal boundary resistance					
18:00	Invited	Christian Huber	<b>Bosch</b> , Is vertical GaN on foreign substrates feasible? Insights from the YESvGaN project					
18:20	Regular	Lars Heuken	<b>Porsche</b> , Elevating Electric Sports Cars: GaN Power Semiconductors Unleashed					
18:30	Invited	Karen Geens	IMEC, GaN power device fabrication for extension to higher voltages					
18:50	Regular	Patrick Diehle	Fraunhofer Institute for Microstructure of Materials and Systems IMWS, Doping investigation of structured GaN devices by highly lateral resolved TOF-SIMS					
END OF DAY 1, 19:00								
INVITED, COMMITTEE & SPONSOR DINNER (INVITATION ONLY)								

	Tuesday June 11, 2024							
	Hotel Due Torri, Verona							
	11A - POWER DEVICES 2							
8:20	Student	Youssef Hamadoui	<b>CNRS-IEMN</b> , High quality fully versus pseudo vertical GaN-on-Silicon pn diodes					
8:30	Invited	Arno Stockman	<b>BelGaN</b> , Dynamic phenomena in 650V p-GaN technology					
8:50	Regular	Nicolò Zagni	<b>University of Modena and Reggio Emilia</b> , Insights from Device Simulations into Trapping Effects in Vertical GaN Power Devices					
9:00	Invited	Gianmauro Pozzovivo	Infineon Technologies Austria AG, GaN Power HEMTs: Next Level of Performance-to-Cost Ratio for Broader Market Adoption					
9:20	Invited	Herbert Pairitsch	<b>Infineon Technologies Austria AG</b> , Power-GaN, the long path from materials science to innovative products					
9:40	Invited	Ferdinando Iucolano	STMicroelectronics, GaN Devices: Industrial trends and challenges					
10:00	Invited	Marnix Tack	GaN Valley, GaN Valley™: a unique ecosystem accelerating GaN innovation and business growth in Europe					
10:20	Invited	Davide Bisi	<b>Transphorm Inc.</b> , Latest Progress on GaN Cascode Devices for High- Power Applications					
10:40			Coffee break					
			11B – GROWTH TECHNIQUES 1					
11:00	Regular	Jan Kuzmik	<b>Slovak Academy of Sciences</b> , InN/InAIN Heterostructures for New Generation of Fast Electronics					
11:10	Invited	Michal Bockowski	Institute of High Pressure Physics of the Polish Academy of Sciences, GaN-on-GaN technology from the perspective of materials science					
11:30	Regular	Elke Meissner	<b>Fraunhofer Institute for Integrated Systems and Device Technology IISB</b> , Growth of thick freestanding 3-inch GaN crystals by vertical downflow HVPE					
11:40	Invited	Christof Mauder	<b>Aixtron SE</b> , 300 mm MOCVD Reactor Technology for Vertical GaN-on- Si Power Devices					
12:00	Regular	Yingying Lin	<b>Nagoya University</b> , Anisotropic hole transport along [0001] and [11-20] direction in p-doped (10-10) GaN					
12:10	Invited	Kazutada Ikenaga	<b>Taiyo Nippon Sanso Corporation</b> , Advancements in MOCVD and Supporting Equipment Technology for GaN					
12:30	Regular	Gaudenzio Meneghesso	University of Padova, The GaN4AP projects: results and challenges					
12:40		Lun	ch break (Hotel Due Torri, Lobby)					
17.70	tono side a lat	Fi 7i	11C - RF DEVICES 2					
13:40	Invited	Enrico Zanoni	University of Padova, Degradation of RF devices  Teledyne Scientific Company, GaN HEMT scaling for millimeter-wave					
14:00	Invited	Keisuke Shinohara	applications					
14:20	Regular	Yvon Cordier	Univ. Côte d'Azur, CNRS, CRHEA, Evaluation of ScAIN/GaN HEMTs grown by ammonia source molecular beam epitaxy					
14:30	Invited	Kozo Makiyama	<b>Sumitomo Electric Industries Ltd.</b> , High-power-density N-polar MIS GaN HEMT for power amplifiers					
14:50	Invited	Jeong-Sun Moon	<b>HRL Laboratories</b> , Millimeter-wave Graded-channel GaN HEMT Technology for 5G and Beyond					
15:10	Student	Hossein Yazdani	<b>Ferdinand-Braun Institute</b> , Si-implantation for Low Ohmic Contact Resistances in RF GaN HEMTs					
15:20			Break					
15:30		Follow ACME people to bus stop						
16:00		Bus transfer to Lazise (45 min)						
		The dialities to Edition (45 illill)						
		Dogana Veneta, Lazise						
17:00		POSTER SESSION						
19:00	Break/Free Time during Dinner Setup (enjoy Lazise and the lakeside!)							
20:00	CONFERENCE DINNER (Dogana Veneta)							
	, <u> </u>							
22:30		First Bus leaves to Verona						
0:00		Second Bus leaves to Verona						

Wednesday June 12, 2024							
	Hotel Due Torri, Verona						
	12A - POWER AND RF DEVICES 3						
8:20	Invited	Mayank Shrivastava	IISC, Physical Insights into the Processes Leading to Dynamic RON and its Mitigation Through Novel Surface Passivation Scheme				
8:40	Invited	Han Wui Then	Intel, 50nm DrGaN in 3D Monolithic GaN MOSHEMT and Silicon PMOS Process on 300mm GaN-on-Si(111)				
9:00	Invited	Elison Matioli	<b>Institute of Electrical and Micro-Engineering, EPFL</b> , Emerging Technologies for GaN-based RF and vertical power devices				
9:20	Invited	Oliver Hilt	<b>Ferdinand-Braun-Institut</b> , AIN-based GaN channel HEMTs on AIN and SiC substrates				
9:40	Regular	Carlo De Santi	University of Padova, p-GaN gate reliability physics				
9:50	Coffee break						
			12B - OPTOELECTRONIC DEVICES 2				
10:10	Regular	Claude Weisbuch	<b>Ecole Polytechnique</b> , What we learned from photo and electro emission experiments in III-nitrides				
10:20	Regular	Matteo Buffolo	University of Padova, Understanding UV LEDs degradation				
10:30	Student	Lukas Uhlig	<b>Chemnitz University of Technology</b> , Fast lateral mode competition phenomena in InGaN broad-ridge laser diodes				
10:40	Invited	Åsa Haglund	<b>Chalmers University of Technology</b> , Ultraviolet (light my way)towards surface- emitting UV lasers				
11:00	Regular	Saulius Marcinkevicius	<b>KTH Royal Institute of Technology</b> , Hole Injection into Quantum Wells of Long Wavelength GaN LEDs				
11:10	Invited	Jan Ruschel	<b>Ferdinand-Braun-Institut</b> , Operation-induced degradation effects in AlGaN-based UV LEDs				
11:30	Regular	Bernd Witzigmann	Friedrich-Alexander Universität Erlangen-Nürnberg (FAU), Impact of alloy fluctuations on optical gain in AlGaN based UV lasers				
CLOSING CEREMONY AND AWARDS – Matteo Meneghini (General Chair), 11:40 to 12:00							

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